

# 3.3-V ABT OCTAL REGISTERED TRANSCEIVERS WITH 3-STATE OUTPUTS

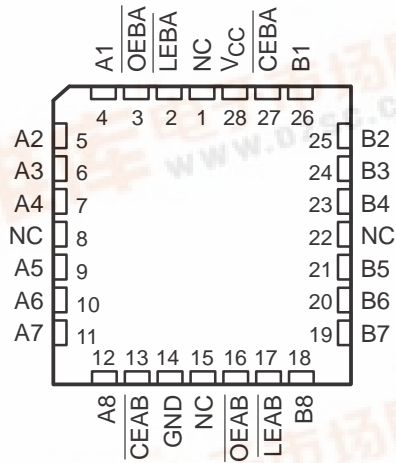
SCBS704F – AUGUST 1997 – REVISED OCTOBER 2003

- Support Mixed-Mode Signal Operation (5-V Input and Output Voltages With 3.3-V  $V_{CC}$ )
- Typical  $V_{OLP}$  (Output Ground Bounce)  $<0.8$  V at  $V_{CC} = 3.3$  V,  $T_A = 25^\circ\text{C}$
- Support Unregulated Battery Operation Down to 2.7 V
- $I_{off}$  and Power-Up 3-State Support Hot Insertion
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Latch-Up Performance Exceeds 500 mA Per JESD 17
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)

SN54LVTH543 . . . JT OR W PACKAGE  
SN74LVTH543 . . . DB, DGV, DW, NS, OR PW PACKAGE  
(TOP VIEW)



SN54LVTH543 . . . FK PACKAGE  
(TOP VIEW)



NC – No internal connection

## description/ordering information

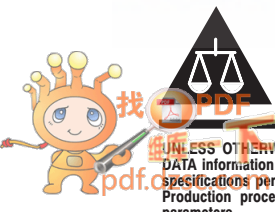
These octal transceivers are designed specifically for low-voltage (3.3-V)  $V_{CC}$  operation, but with the capability to provide a TTL interface to a 5-V system environment.

## ORDERING INFORMATION

$T_A$	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 85°C	SOIC – DW	Tube	SN74LVTH543DW	LVTH543
		Tape and reel	SN74LVTH543DWR	
	SOP – NS	Tape and reel	SN74LVTH543NSR	LVTH543
	SSOP – DB	Tape and reel	SN74LVTH543DBR	LXH543
	TSSOP – PW	Tube	SN74LVTH543PW	LXH543
		Tape and reel	SN74LVTH543PWR	
	TVSOP – DGV	Tape and reel	SN74LVTH543DGVR	LXH543
–55°C to 125°C	CDIP – JT	Tube	SNJ54LVTH543JT	SNJ54LVTH543JT
	CFP – W	Tube	SNJ54LVTH543W	SNJ54LVTH543W
	LCCC – FK	Tube	SNJ54LVTH543FK	SNJ54LVTH543FK

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).

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# SN54LVTH543, SN74LVTH543

## 3.3-V ABT OCTAL REGISTERED TRANSCEIVERS WITH 3-STATE OUTPUTS

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### description/ordering information (continued)

The LVTH543 devices contain two sets of D-type latches for temporary storage of data flowing in either direction. Separate latch-enable ( $\overline{LEAB}$  or  $\overline{LEBA}$ ) and output-enable ( $\overline{OEAB}$  or  $\overline{OEBA}$ ) inputs are provided for each register, to permit independent control in either direction of data flow.

The A-to-B enable ( $\overline{CEAB}$ ) input must be low to enter data from A or to output data from B. If  $\overline{CEAB}$  is low and  $\overline{LEAB}$  is low, the A-to-B latches are transparent; a subsequent low-to-high transition of  $\overline{LEAB}$  puts the A latches in the storage mode. With  $\overline{CEAB}$  and  $\overline{OEAB}$  both low, the 3-state B outputs are active and reflect the data present at the output of the A latches. Data flow from B to A is similar, but requires using the  $\overline{CEBA}$ ,  $\overline{LEBA}$ , and  $\overline{OEBA}$  inputs.

Active bus-hold circuitry holds unused or undriven inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

When  $V_{CC}$  is between 0 and 1.5 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 1.5 V,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

This device is fully specified for hot-insertion applications using  $I_{off}$  and power-up 3-state. The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down. The power-up 3-state circuitry places the outputs in the high-impedance state during power up and power down, which prevents driver conflict.

FUNCTION TABLE†

INPUTS				OUTPUT
$\overline{CEAB}$	$\overline{LEAB}$	$\overline{OEAB}$	A	B
H	X	X	X	Z
X	X	H	X	Z
L	H	L	X	$B_0^\ddagger$
L	L	L	L	L
L	L	L	H	H

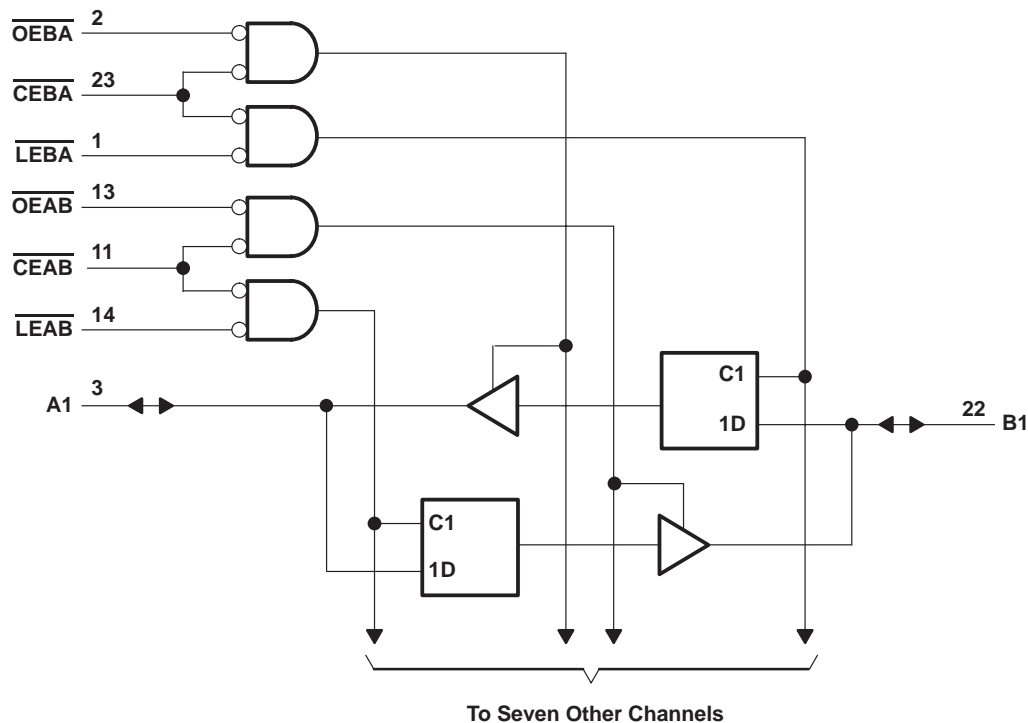
† A-to-B data flow is shown; B-to-A flow control is the same, except that it uses  $\overline{CEBA}$ ,  $\overline{LEBA}$ , and  $\overline{OEBA}$ .

‡ Output level before the indicated steady-state input conditions were established

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## logic diagram (positive logic)



Pin numbers shown are for the DB, DGV, DW, JT, NS, PW, and W packages.

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, $V_{CC}$ .....	-0.5 V to 4.6 V
Input voltage range, $V_I$ (see Note 1) .....	-0.5 V to 7 V
Voltage range applied to any output in the high-impedance or power-off state, $V_O$ (see Note 1) .....	-0.5 V to 7 V
Voltage range applied to any output in the high state, $V_O$ (see Note 1) .....	-0.5 V to $V_{CC} + 0.5$ V
Current into any output in the low state, $I_O$ : SN54LVTH543 .....	96 mA
SN74LVTH543 .....	128 mA
Current into any output in the high state, $I_O$ (see Note 2): SN54LVTH543 .....	48 mA
SN74LVTH543 .....	64 mA
Input clamp current, $I_{IK}$ ( $V_I < 0$ ) .....	-50 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ ) .....	-50 mA
Package thermal impedance, $\theta_{JA}$ (see Note 3): DB package .....	63°C/W
DGV package .....	86°C/W
DW package .....	46°C/W
NS package .....	65°C/W
PW package .....	88°C/W
Storage temperature range, $T_{Stg}$ .....	-65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.  
 2. This current flows only when the output is in the high state and  $V_O > V_{CC}$ .  
 3. The package thermal impedance is calculated in accordance with JESD 51-7.

**SN54LVTH543, SN74LVTH543**  
**3.3-V ABT OCTAL REGISTERED TRANSCEIVERS**  
**WITH 3-STATE OUTPUTS**

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**recommended operating conditions (see Note 4)**

		SN54LVTH543		SN74LVTH543		UNIT
		MIN	MAX	MIN	MAX	
V <sub>CC</sub>	Supply voltage	2.7	3.6	2.7	3.6	V
V <sub>IH</sub>	High-level input voltage	2		2		V
V <sub>IL</sub>	Low-level input voltage		0.8		0.8	V
V <sub>I</sub>	Input voltage		5.5		5.5	V
I <sub>OH</sub>	High-level output current		-24		-32	mA
I <sub>OL</sub>	Low-level output current		48		64	mA
Δt/Δv	Input transition rise or fall rate	Outputs enabled		10	10	ns/V
Δt/ΔV <sub>CC</sub>	Power-up ramp rate	200		200		μs/V
T <sub>A</sub>	Operating free-air temperature	-55	125	-40	85	°C

NOTE 4: All unused control inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

# SN54LVTH543, SN74LVTH543 3.3-V ABT OCTAL REGISTERED TRANSCEIVERS WITH 3-STATE OUTPUTS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	SN54LVTH543			SN74LVTH543			UNIT
			MIN	TYP†	MAX	MIN	TYP†	MAX	
V <sub>IK</sub>		V <sub>CC</sub> = 2.7 V, I <sub>I</sub> = -18 mA	-1.2			-1.2			V
V <sub>OH</sub>		V <sub>CC</sub> = 2.7 V to 3.6 V, I <sub>OH</sub> = -100 μA	V <sub>CC</sub> -0.2			V <sub>CC</sub> -0.2			V
		V <sub>CC</sub> = 2.7 V, I <sub>OH</sub> = -8 mA	2.4			2.4			
		V <sub>CC</sub> = 3 V	2			2			
I <sub>OH</sub> = -24 mA									
V <sub>OL</sub>		V <sub>CC</sub> = 2.7 V	I <sub>OL</sub> = 100 μA			0.2			V
			I <sub>OL</sub> = 24 mA			0.5			
		V <sub>CC</sub> = 3 V	I <sub>OL</sub> = 16 mA			0.4			
			I <sub>OL</sub> = 32 mA			0.5			
			I <sub>OL</sub> = 48 mA			0.55			
			I <sub>OL</sub> = 64 mA			0.55			
I <sub>I</sub>		Control inputs	V <sub>CC</sub> = 3.6 V, V <sub>I</sub> = V <sub>CC</sub> or GND		±1			μA	
			V <sub>CC</sub> = 0 or 3.6 V, V <sub>I</sub> = 5.5 V		10				
		A or B ports‡	V <sub>CC</sub> = 3.6 V, V <sub>I</sub> = 5.5 V		20				
			V <sub>CC</sub> = 3.6 V, V <sub>I</sub> = V <sub>CC</sub>		1				
		V <sub>CC</sub> = 3.6 V, V <sub>I</sub> = 0		-5					
I <sub>off</sub>		V <sub>CC</sub> = 0, V <sub>I</sub> or V <sub>O</sub> = 0 to 4.5 V				±100			
I <sub>I</sub> (hold)		A or B ports	V <sub>CC</sub> = 3 V, V <sub>I</sub> = 0.8 V		75			μA	
			V <sub>CC</sub> = 3 V, V <sub>I</sub> = 2 V		-75				
		V <sub>CC</sub> = 3.6 V§, V <sub>I</sub> = 0 to 3.6 V		±500					
I <sub>OZPU</sub>		V <sub>CC</sub> = 0 to 1.5 V, V <sub>O</sub> = 0.5 to 3 V, OE = don't care	±100*			±100			
I <sub>OZPD</sub>		V <sub>CC</sub> = 1.5 V to 0, V <sub>O</sub> = 0.5 to 3 V, OE = don't care	±100*			±100			
I <sub>CC</sub>		V <sub>CC</sub> = 3.6 V, I <sub>O</sub> = 0, V <sub>I</sub> = V <sub>CC</sub> or GND	Outputs high		0.19			mA	
			Outputs low		5				
			Outputs disabled		0.19				
ΔI <sub>CC</sub> ¶		V <sub>CC</sub> = 3 V to 3.6 V, One input at V <sub>CC</sub> - 0.6 V, Other inputs at V <sub>CC</sub> or GND	0.2			0.2			
C <sub>i</sub>		V <sub>I</sub> = 3 V or 0	4			4			
C <sub>io</sub>		V <sub>O</sub> = 3 V or 0	9			9			

\* On products compliant to MIL-PRF-38535, this parameter is not production tested.

† All typical values are at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C.

‡ Unused terminals are at V<sub>CC</sub> or GND.

§ This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.

¶ This is the increase in supply current for each input that is at the specified TTL voltage level, rather than V<sub>CC</sub> or GND.

# SN54LVTH543, SN74LVTH543

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timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

			SN54LVTH543				SN74LVTH543				UNIT	
			V <sub>CC</sub> = 3.3 V ± 0.3 V		V <sub>CC</sub> = 2.7 V		V <sub>CC</sub> = 3.3 V ± 0.3 V		V <sub>CC</sub> = 2.7 V			
			MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX		
t <sub>w</sub>	Pulse duration, $\overline{\text{LEAB}}$ or $\overline{\text{LEBA}}$ low		3.3		3.3		3.3		3.3		ns	
t <sub>su</sub>	Setup time	A or B before $\overline{\text{LEAB}}$ or $\overline{\text{LEBA}}\uparrow$	Data high	0.4		0.4		0.4		0.4		ns
			Data low	1		1.5		1		1.5		
		A or B before $\overline{\text{CEAB}}$ or $\overline{\text{CEBA}}\uparrow$	Data high	0.2		0.2		0.2		0.2		
			Data low	0.7		1.2		0.7		1.2		
t <sub>h</sub>	Hold time	A or B after $\overline{\text{LEAB}}$ or $\overline{\text{LEBA}}\uparrow$	Data high	1.5		0.6		1.5		0.6		ns
			Data low	1.3		1.5		1.3		1.5		
		A or B after $\overline{\text{CEAB}}$ or $\overline{\text{CEBA}}\uparrow$	Data high	1.6		0.5		1.6		0.5		
			Data low	1.4		1.6		1.4		1.6		

switching characteristics over recommended operating free-air temperature range, C<sub>L</sub> = 50 pF (unless otherwise noted) (see Figure 1)

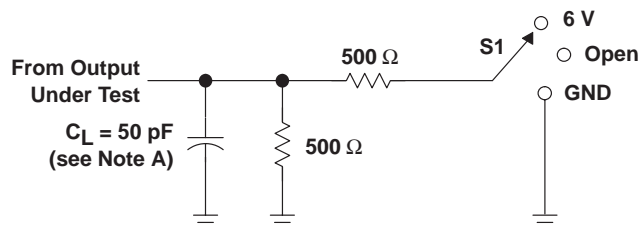
PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54LVTH543				SN74LVTH543				UNIT	
			V <sub>CC</sub> = 3.3 V ± 0.3 V		V <sub>CC</sub> = 2.7 V		V <sub>CC</sub> = 3.3 V ± 0.3 V			V <sub>CC</sub> = 2.7 V		
			MIN	MAX	MIN	MAX	MIN	TYP†	MAX	MIN		MAX
t <sub>PLH</sub>	A or B	B or A	1.2	3.9		4.5	1.3	2.5	3.7		4.3	ns
t <sub>PHL</sub>			1.2	3.9		4.5	1.3	2.5	3.7		4.3	
t <sub>PLH</sub>	$\overline{\text{LE}}$	A or B	1.2	5.1		6.1	1.3	2.9	4.7		5.9	ns
t <sub>PHL</sub>			1.2	5.1		6.1	1.3	2.9	4.7		5.9	
t <sub>PZH</sub>	$\overline{\text{OE}}$	A or B	1	5.1		6.4	1.1	2.9	4.9		6.2	ns
t <sub>PZL</sub>			1	5.1		6.4	1.1	3.2	4.9		6.2	
t <sub>PHZ</sub>	$\overline{\text{OE}}$	A or B	1.9	5.6		6.2	2	3.4	5.3		5.9	ns
t <sub>PLZ</sub>			1.9	5.6		6.2	2	3.7	5.3		5.9	
t <sub>PZH</sub>	$\overline{\text{CE}}$	A or B	1.2	5.5		7	1.3	3.2	5.3		6.8	ns
t <sub>PZL</sub>			1.2	5.5		7	1.3	3.5	5.3		6.8	
t <sub>PHZ</sub>	$\overline{\text{CE}}$	A or B	2.2	5.7		6.2	2.3	3.8	5.4		5.9	ns
t <sub>PLZ</sub>			2.2	5.7		5.9	2.3	3.9	5.4		5.6	

† All typical values are at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C.

# SN54LVTH543, SN74LVTH543 3.3-V ABT OCTAL REGISTERED TRANSCEIVERS WITH 3-STATE OUTPUTS

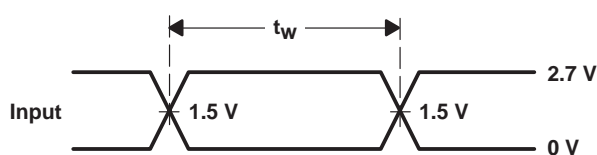
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## PARAMETER MEASUREMENT INFORMATION

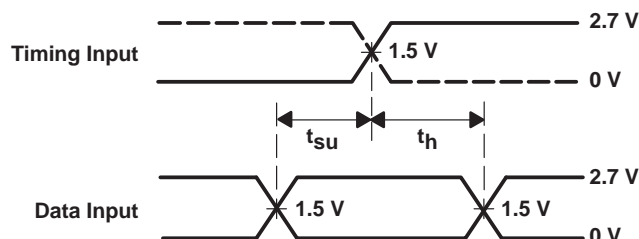


LOAD CIRCUIT

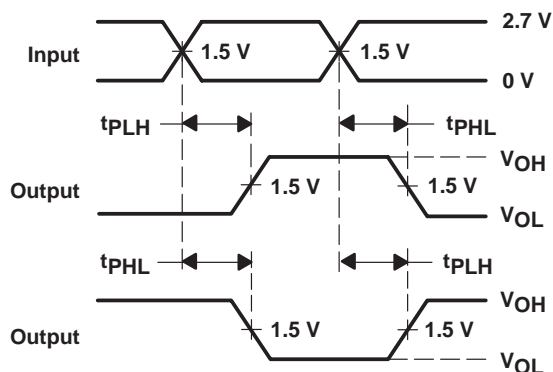
TEST	S1
$t_{PLH}/t_{PHL}$	Open
$t_{PLZ}/t_{PZL}$	6 V
$t_{PHZ}/t_{PZH}$	GND



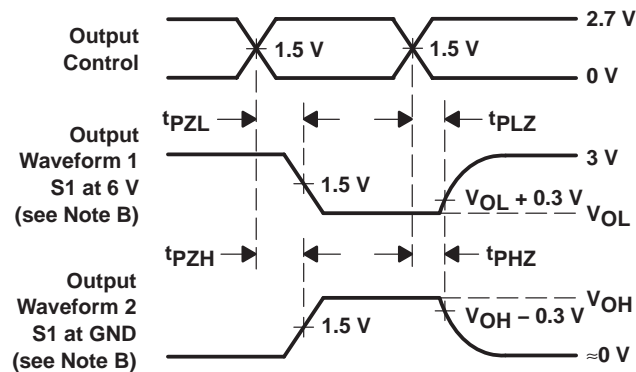
VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES  
LOW- AND HIGH-LEVEL ENABLING

- NOTES:
- $C_L$  includes probe and jig capacitance.
  - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5 \text{ ns}$ ,  $t_f \leq 2.5 \text{ ns}$ .
  - The outputs are measured one at a time with one transition per measurement.
  - All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

**PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
SN74LVTH543DBLE	OBSOLETE	SSOP	DB	24		TBD	Call TI	Call TI
SN74LVTH543DBR	ACTIVE	SSOP	DB	24	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74LVTH543DGVR	ACTIVE	TVSOP	DGV	24	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
SN74LVTH543DW	ACTIVE	SOIC	DW	24	25	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
SN74LVTH543DWR	ACTIVE	SOIC	DW	24	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
SN74LVTH543NSR	ACTIVE	SO	NS	24	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74LVTH543PW	ACTIVE	TSSOP	PW	24	60	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
SN74LVTH543PWLE	OBSOLETE	TSSOP	PW	24		TBD	Call TI	Call TI
SN74LVTH543PWR	ACTIVE	TSSOP	PW	24	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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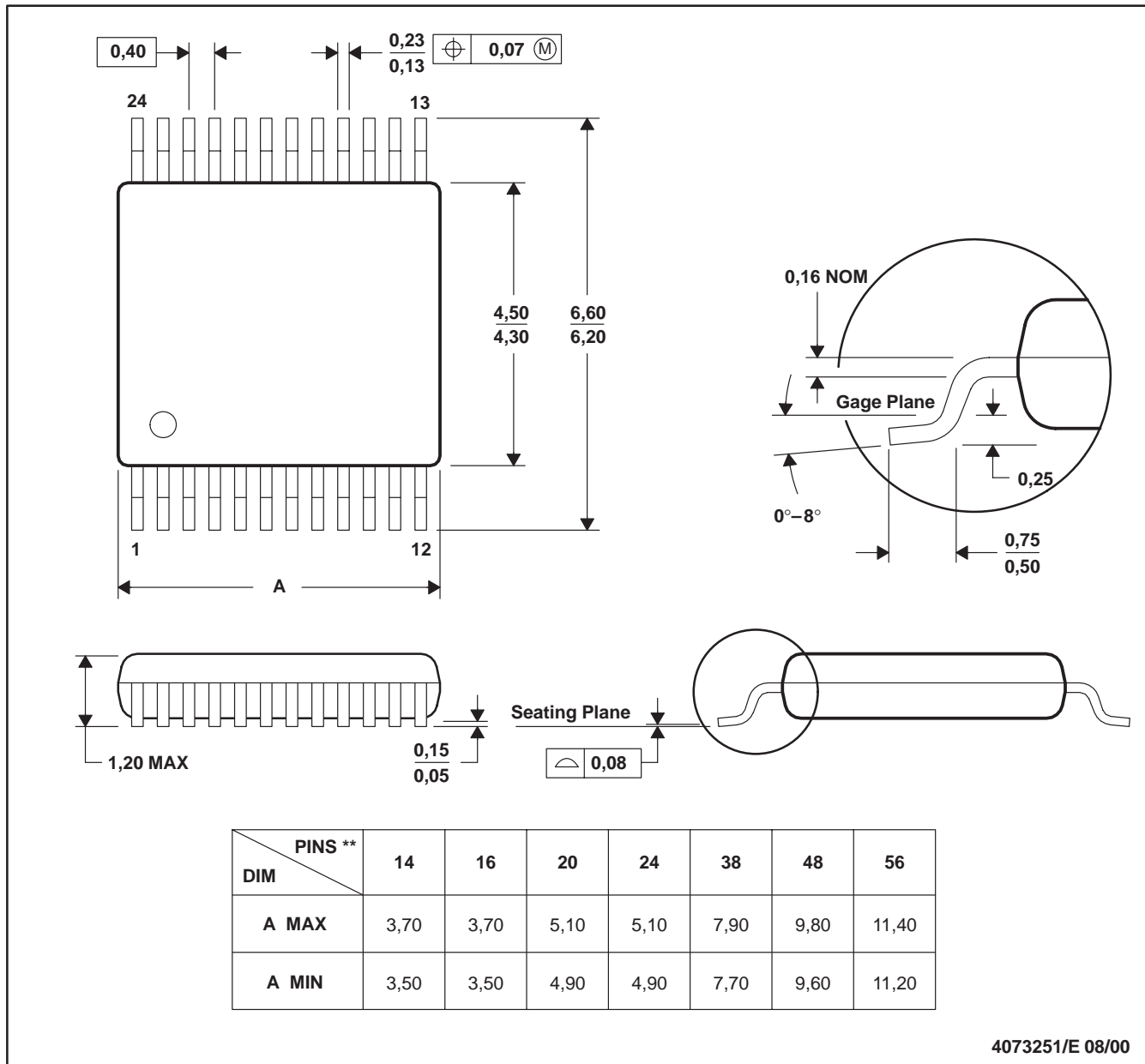
# MECHANICAL DATA

MPDS006C – FEBRUARY 1996 – REVISED AUGUST 2000

## DGV (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

24 PINS SHOWN

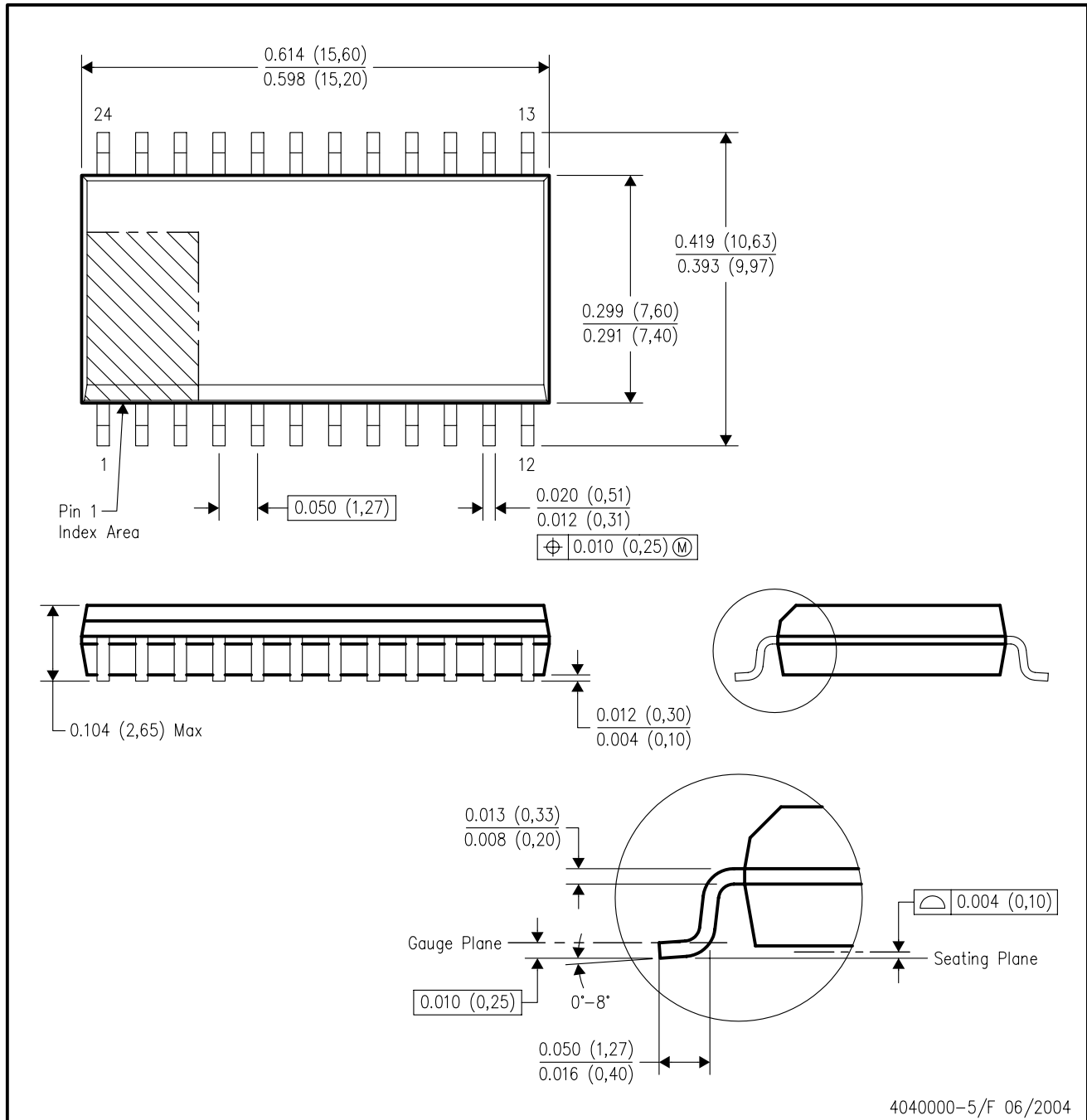


- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.  
 D. Falls within JEDEC: 24/48 Pins – MO-153  
 14/16/20/56 Pins – MO-194

# MECHANICAL DATA

DW (R-PDSO-G24)

PLASTIC SMALL-OUTLINE PACKAGE



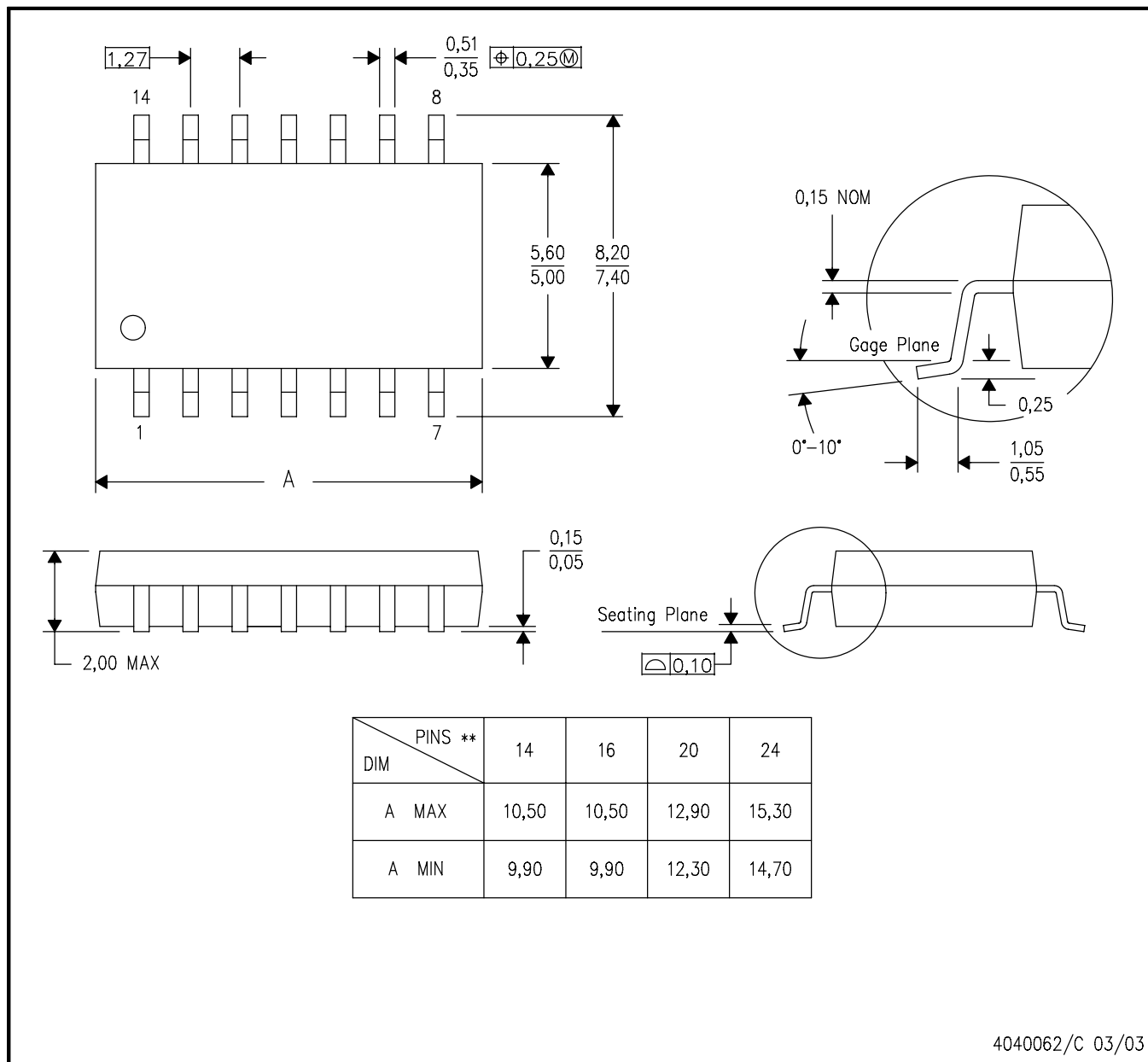
- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
  - Falls within JEDEC MS-013 variation AD.

## MECHANICAL DATA

**NS (R-PDSO-G\*\*)**

**PLASTIC SMALL-OUTLINE PACKAGE**

**14-PINS SHOWN**



4040062/C 03/03

- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

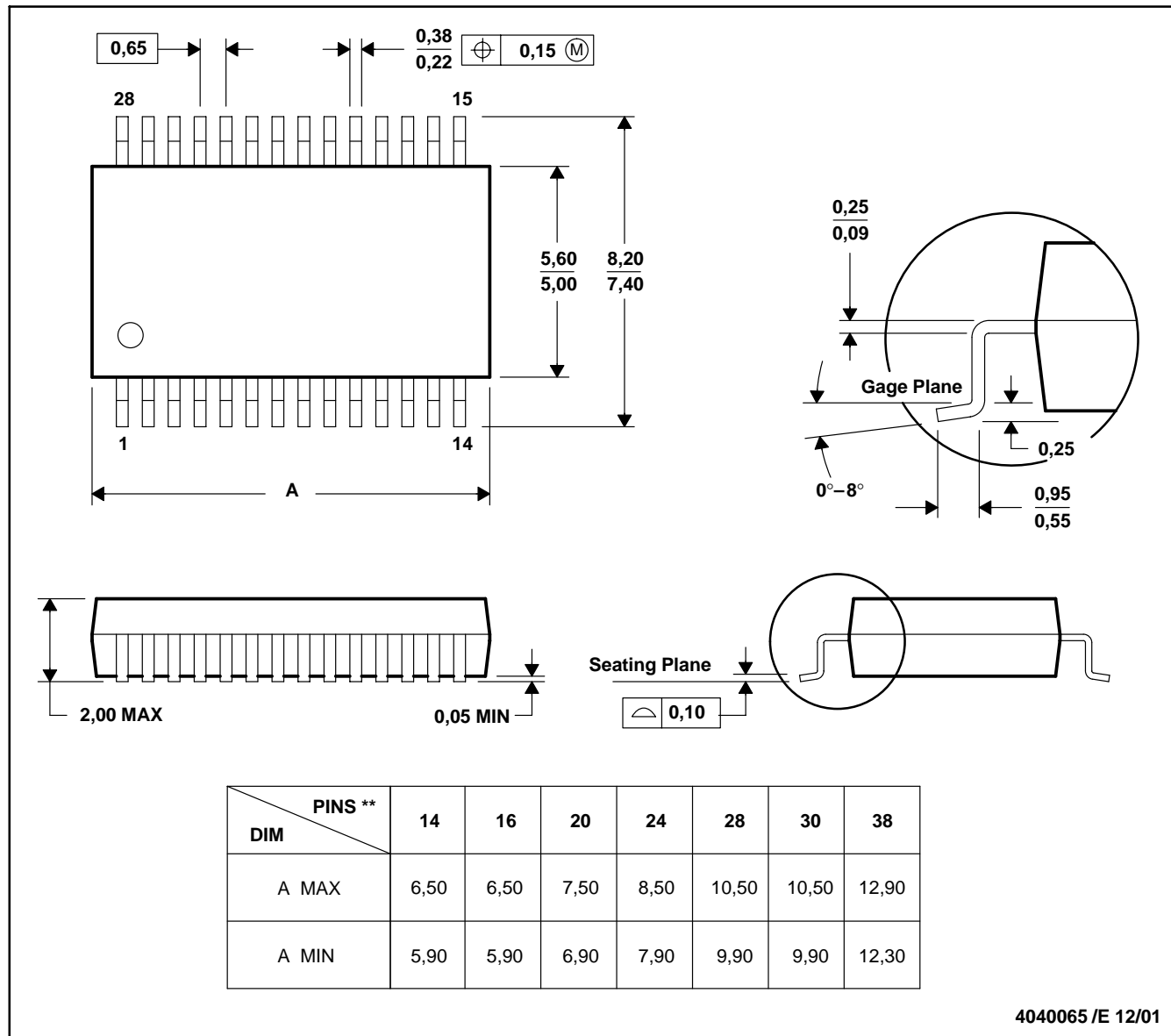
# MECHANICAL DATA

MSS0002E – JANUARY 1995 – REVISED DECEMBER 2001

## DB (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

28 PINS SHOWN



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion not to exceed 0,15.
  - Falls within JEDEC MO-150

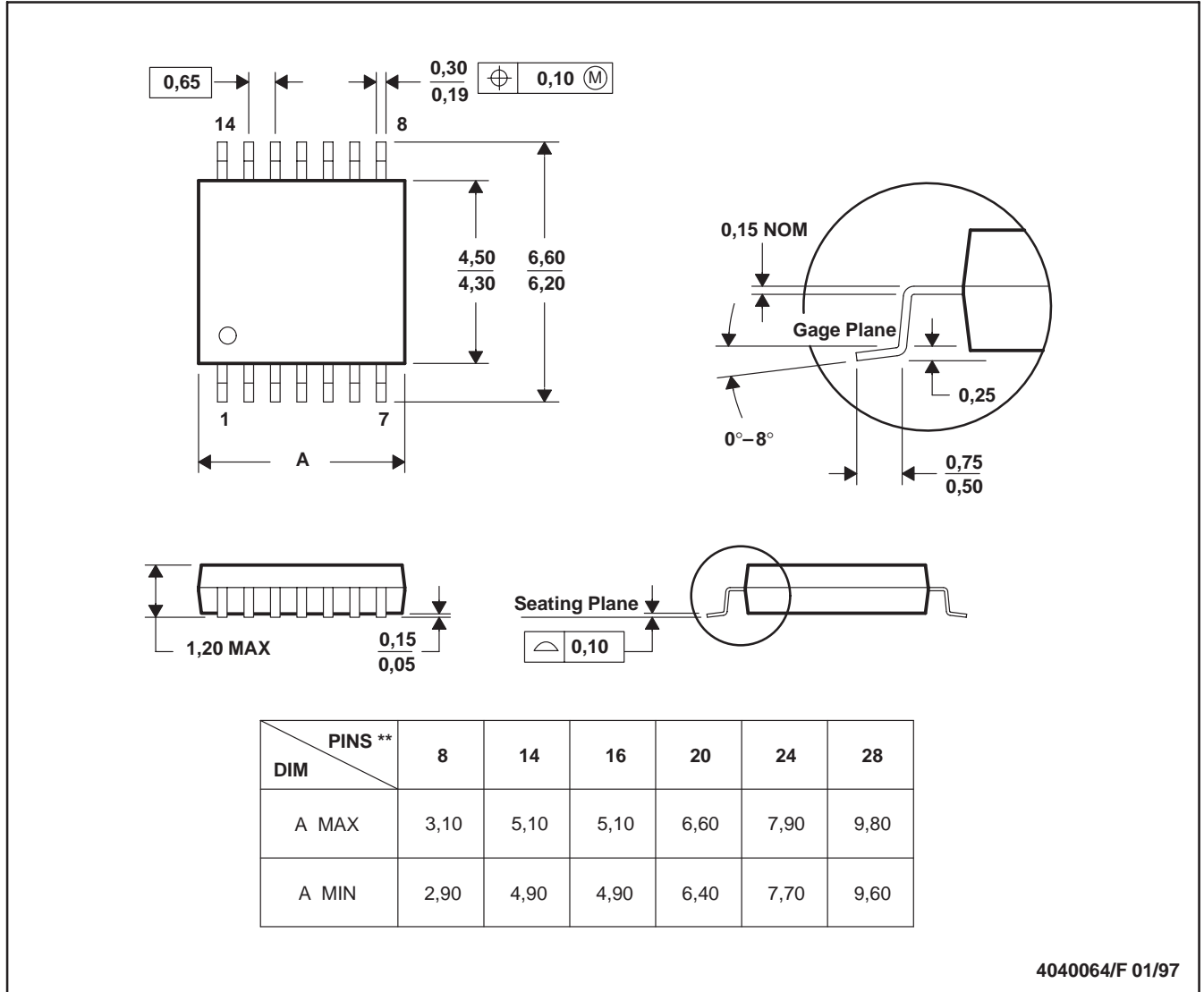
# MECHANICAL DATA

MTSS001C – JANUARY 1995 – REVISED FEBRUARY 1999

**PW (R-PDSO-G\*\*)**

**PLASTIC SMALL-OUTLINE PACKAGE**

14 PINS SHOWN



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion not to exceed 0,15.
  - Falls within JEDEC MO-153

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